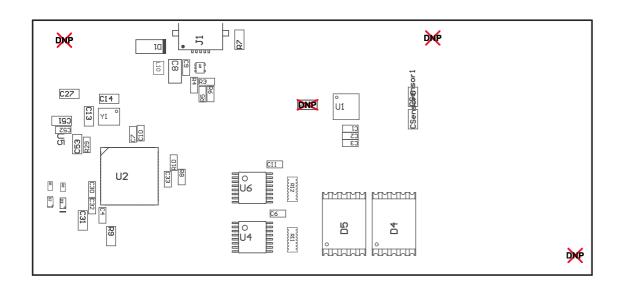
ZZ1 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZZ ■These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00615	REV: E1	SUN REU:	Not In VersionControl		
	TID #: TIDA-00615					
PLOT NAME = Top Assembly Drawing	GENERATED : 11/23/	2015 4: 37: 25	PM	TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00615	REV: E1	SUN REU	: Not In VersionControl	
	TID #: TIDA-00615				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/23/	2015 4:37:26	PM	TEXAS INSTRUMENTS	

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